

Advance Information

MPC7410RXNEPNS/D Rev. 1, 10/2002

MPC7410 Part Number Specification for the MPC7410RXnnnNE Series

Motorola Part Numbers Affected: MPC7410RX400NE

MPC7410RX400NE MPC7410RX450NE Freescale Semiconductor, Inc.



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This document describes part-number-specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC7410 Hardware Specifications* (order #: MPC7410EC/D).

Specifications provided in this document supersede those in the *MPC7410 Hardware Specifications*, for the part numbers listed in Table A only. Specifications not addressed herein are unchanged. Because this document is frequently updated, refer to http://www.motorola.com/semiconductors or to your Motorola sales office for the latest version.

Note that headings and table numbers in this document are not consecutively numbered. They are intended to correspond to the heading or table affected in the general hardware specification. Part numbers addressed in this document are listed in Table A. For more detailed ordering information, see Table 17.



Motorola Part		Operating Co	onditions	5	Significant Differences from Hardware	
Number	CPU Frequency	Vdd	Т _Ј (°С)	OVdd	Specification	
MPC7410RX400NE	400 MHz	1.5V±50mV	0 to 105	1.8/2.5 V	Reduced core voltage to achieve lower power consumption. Removes 3.3V OVdd support. For all AC/DC specifications not mentioned in this document, please refer to the MPC7410RX400LE specifications in the general <i>MPC7410 Hardware Specifications</i> .	
	450 MHz	1.8V ±100mV	0 to 105	1.8/2.5/3.3 V	The MPC7410RX400NE also fully conforms to the MPC7410RX450LE specification. Refer to the general <i>MPC7410 Hardware Specifications</i> .	
MPC7410RX450NE	450 MHz	1.5V±50mV	0 to 105	1.8/2.5 V	Reduced core voltage to achieve lower power consumption.Removes 3.3V OVdd support. For all AC/DC specifications not mentioned in this document, please refer to the MPC7410RX450LE specifications in the general <i>MPC7410 Hardware Specifications</i> .	
	500 MHz	1.8V ±100mV	0 to 105	1.8/2.5/3.3 V	The MXPC7410RX450NE also fully conforms to the MPC7410RX500LE specification. Refer to the general <i>MPC7410 Hardware Specifications</i> .	

Table A. Part Numbers Addressed by this Data Sheet

1.2 Features

This section summarizes changes to the features of the MPC7410 described in the MPC7410 Hardware Specifications.

- Bus interface
 - Selectable interface voltages of 1.8 V, 2.5 V (3.3 V not supported)

1.4.1 DC Electrical Characteristics

Voltage to the L2 I/Os and processor interface I/Os are provided through separate sets of supply pins and may be provided at the voltages shown in Table 2.



BVSEL Signal ³	Processor Bus Input Threshold is Relative to:	L2VSEL Signal ³	L2 Bus Input Threshold is Relative to:	Note
0	1.8 V	0	1.8 V	1
HRESET	2.5 V	HRESET	2.5 V	1, 2
1	Not Supported	1	2.5 V	1, 4, 5
HRESET	Not Supported	HRESET	Not Supported	

Table 2. Input Threshold Voltage Setting

Notes:

1. Caution: The input threshold selection must agree with the OVdd/L2OVdd voltages supplied.

2. To select the 2.5-V threshold option, BVSEL and/or L2VSEL should be tied to HRESET so that the two signals change state together. This is the preferred method for selecting this mode of operation.

3. To overcome the internal pull-up resistance, a pull-down resistance less than 250 ohms should be used.

4. Default voltage setting if left unconnected (internal pulled-up).

5. Caution: The XPC7410RXnnnNE does not support the default OVdd setting of 3.3 V. The BVSEL input must be tie either low or to HRESET.

 Table 3 provides the recommended operating conditions for the MPC7410 part numbers described herein.

 Table 3. Recommended Operating Conditions

Characteris	stic	Symbol Recommended Value		Unit
Core supply voltage		Vdd	1.5V ± 50mV	V
PLL supply voltage		AVdd	1.5V ± 50mV	V V
L2 DLL supply voltage		L2AVdd	1.5V ± 50mV	
Processor bus supply voltage	BVSEL = 0	OVdd	1.8V ± 100mV	V
	BVSEL = HRESET	OVdd	2.5V ± 100mV	V
	BVSEL = HRESET or BVSEL = 1	OVdd	Not Supported	V
L2 bus supply voltage	L2VSEL = 0	L2OVdd	1.8V ± 100mV	V
	L2VSEL = HRESET or L2VSEL = 1	L2OVdd	2.5V ± 100mV	V
Input voltage	Processor bus and JTAG Signals	V _{in}	GND to OVdd	V
	L2 Bus	V _{in}	GND to L2OVdd	V
Die-junction temperature	<u> </u>	T _i	0-105	°C

Table 7 provides the power consumption for the MPC7410 part at the frequencies described herein.



Processor Processor (CPU) (CPU) Frequency Frequency Unit Notes 400Mhz 450Mhz Full-On Mode Typical 2.92 3.29 W 1, 3 6.6 7.43 W 1, 2, Maximum Doze Mode 4.1 W 1, 2 Maximum 3.6 Nap Mode W Maximum 1.35 1.5 1, 2 Sleep Mode Maximum 1.3 1.45 W 1, 2 Sleep Mode—PLL and DLL Disabled Typical 0.6 W 1, 3 0.6 Maximum 1.1 1.1 W 1, 2

Table 7. Power Consumption for MPC7410

Notes:

- These values apply for all valid processor bus and L2 bus ratios. The values do not include I/O Supply Power (OVdd and L2OVdd) or PLL/DLL supply power (AVdd and L2AVdd). OVdd and L2OVdd power is system dependent, but is typically <10% of Vdd power. Worst case power consumption for AVdd = 15 mw and L2AVdd = 15 mW.
- Maximum power is measured at 105 °C and Vdd = 1.5V while running an entirely cache-resident, contrived sequence of instructions which keep the execution units, including AltiVec, maximally busy.
- 3. Typical power is an average value measured at 65 °C and Vdd = 1.5V in a system while running typical benchmarks.

1.9 Document Revision History

Table 16 provides a revision history for this Part Number Specification.

Table 16. Document Revision History

Document Revision	Substantive Changes		
Rev 0	Initial Release		
Rev 1	Minor formatting		
	Added Section 1.9 Document Revision History		
	Section 1.10.1 - added Table 17 - Part-Marking Nomenclature		



1.10 Ordering Information

1.10.1 Part Numbers Addressed by this Specification

XXX

Table 17 provides the ordering information for the MPC7410 part described in this document.

Table 17. Part-Marking Nomenclature

MPC 7410	RX
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X

V
x

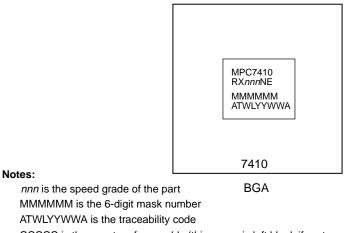
Product Code	Part Identifier	Package	Processor Frequency ¹	Application Modifier	Revision Level
MPC	7410	RX = CBGA	400 450	N: 1.5 V ± 50 mV 0 to 105 °C	E: 1.4; PVR = 800C 1104

Notes:

1. Processor core frequencies supported by parts addressed by this specification only. Parts addressed by other specifications may support other maximum core frequencies.

1.10.3 Part Marking

Parts are marked as the example shown in Figure 26.



CCCCC is the country of assembly (this space is left blank if parts are assembled in the United States)

Figure 26. Motorola Part Marking for BGA Device



Ordering Information



Ordering Information



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MPC7410RXNEPNS/D